

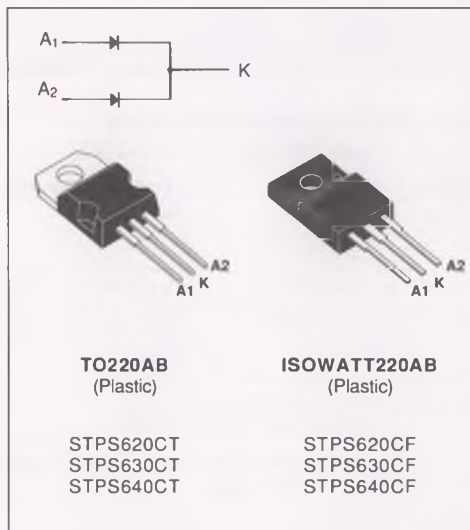
POWER SCHOTTKY RECTIFIER

- VERY SMALL CONDUCTION LOSSES
- NEGLIGIBLE SWITCHING LOSSES
- EXTREMELY FAST SWITCHING
- LOW FORWARD VOLTAGE DROP
- HIGH AVALANCHE CAPABILITY
- LOW THERMAL RESISTANCE
- INSULATED PACKAGE :
Insulating voltage = 2000V DC
Capacitance = 12pF

DESCRIPTION

Dual center tap schottky rectifier suited for switch-mode power supply and high frequency DC to DC converters.

Packaged in TO220AB and ISOWATT220AB, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter			Value	Unit
$I_{F(RMS)}$	RMS Forward Current			Per diode	10 A
$I_{F(AV)}$	Average Forward Current $\delta = 0.5$	TO220AB	$T_c = 135^\circ\text{C}$	Per diode	3 A
		ISOWATT220AB	$T_c = 130^\circ\text{C}$	Per device	6
I_{FSM}	Surge Non Repetitive Forward Current			$T_p = 10$ ms Sinusoidal	Per diode 75 A
I_{RRM}	Peak Repetitive Reverse Current			$T_p = 2$ μs $F = 1$ KHz	Per diode 1 A
T_{stg} T_j	Storage and Junction Temperature Range			- 65 to + 150 - 65 to + 150	$^\circ\text{C}$
dV/dt	Critical Rate of Rise of Reverse Voltage			1000	V/ μs

Symbol	Parameter	STPS			Unit
		620CT 620CF	630CT 630CF	640CT 640CF	
V_{RRM}	Repetitive Peak Reverse Voltage	20	30	40	V

THERMAL RESISTANCE

Symbol	Parameter		Value	Unit
R _{TH(j-c)}	Junction-case	TO220AB	Per diode total 5.5 3.0	°C/W
		ISOWATT220AB	Per diode total 7.5 5.2	
R _{TH(c)}	Coupling	TO220AB	0.5	°C/W
		ISOWATT220AB	3	

When the diodes 1 and 2 are used simultaneously :
 $\Delta T_J(\text{diode } 1) = P(\text{diode } 1) \times R_{TH(\text{Per diode})} + P(\text{diode } 2) \times R_{TH(c)}$

ELECTRICAL CHARACTERISTICS

STATIC CHARACTERISTICS PER DIODE

Symbol	Tests Conditions		Min.	Typ.	Max.	Unit
I _R *	T _j = 25°C	V _R = V _{RRM}			100	μA
	T _j = 125°C				10	mA
V _F **	T _j = 125°C	I _F = 6 A			0.72	V
	T _j = 125°C	I _F = 3 A			0.57	
	T _j = 25°C	I _F = 6 A			0.84	

Pulse test : * t_p = 5 ms, duty cycle < 2 %
 ** t_p = 380 μs, duty cycle < 2%

To evaluate the conduction losses use the following equation :
 $P = 0.42 \times I_{F(AV)} + 0.050 I_{F(RMS)}^2$

Fig. 1 : Average forward power dissipation versus average forward current. (Per diode)

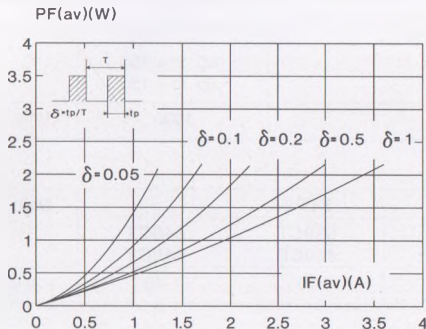


Fig. 2 : Average current versus ambient temperature. (duty cycle : 0.5) (Per diode) (TO220AB)

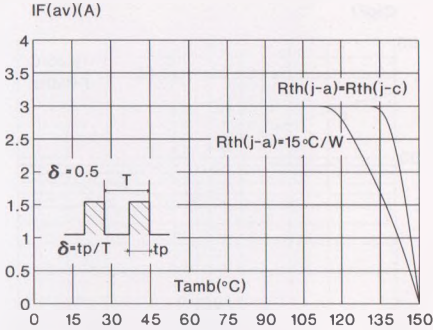


Fig. 3 : Average current versus ambient temperature. (duty cycle : 0.5) (Per diode) (ISOWATT220AB)

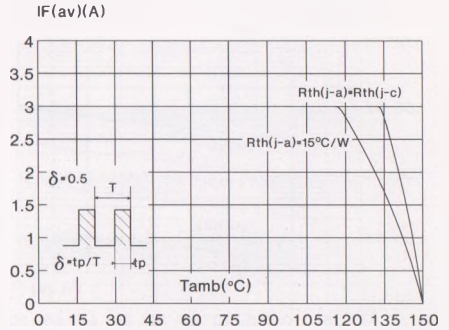


Fig. 4 : Non repetitive surge peak forward current versus overload duration. (Maximum values) (Per diode) (TO220AB)

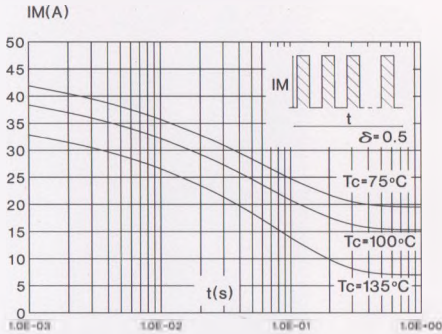


Fig. 5 : Non repetitive surge peak forward current versus overload duration. (Maximum values) (Per diode) (ISOWATT220AB)

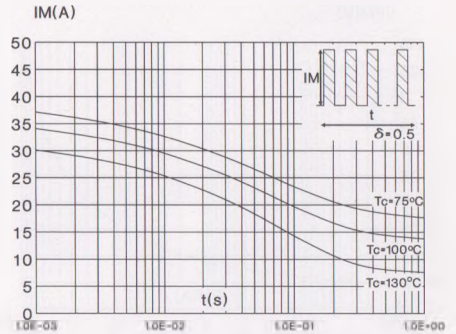


Fig. 6 : Relative variation of thermal transient impedance junction to case versus pulse duration. (TO220AB)

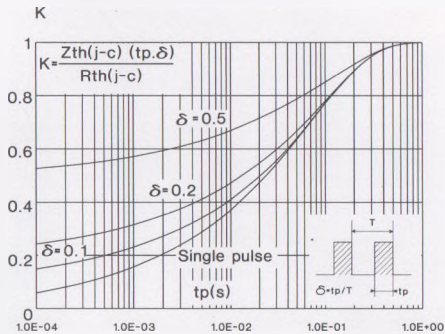


Fig. 7 : Relative variation of thermal transient impedance junction to case versus pulse duration. (ISOWATT220AB)

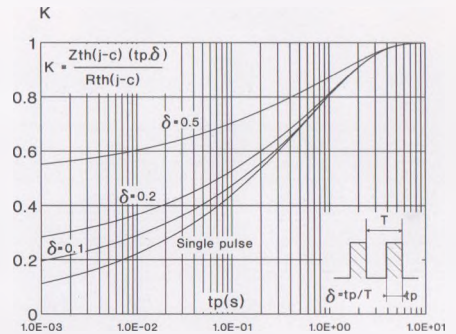


Fig. 8 : Reverse leakage current versus reverse voltage applied. (Typical values) (Per diode)

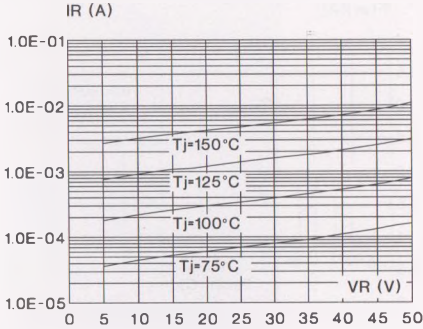


Fig. 9 : Junction capacitance versus reverse voltage applied. (Typical values) (Per diode)

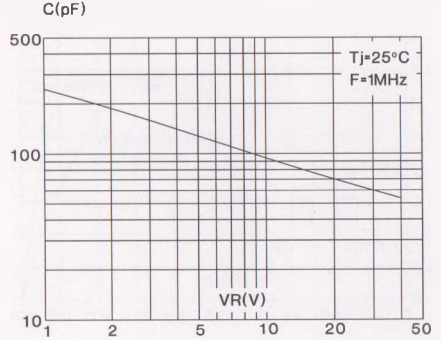


Fig. 10 : Forward voltage drop versus forward current. (Maximum values) (Per diode)

